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#### NOT RECOMMENDED FOR NEW DESIGN USE <u>AH1806</u>



AH1802

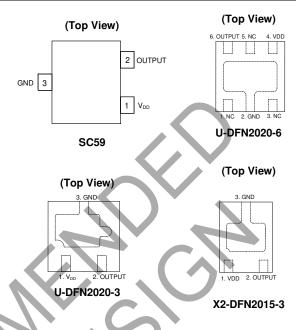
MICROPOWER, ULTRA-SENSITIVE OMNIPOLAR HALL-EFFECT SENSOR SWITCH

#### Description

The AH1802 is a high-sensitivity, micropower, omnipolar Hall Effect switch integrated circuit (IC) designed for portable and battery-powered equipment, such as cellular phones, PDAs, and portable PCs. Based on two sensitive Hall Effect plates and a chopper-stabilized architecture, the AH1802 provides a reliable solution over the whole operating range. To support portable and battery-powered equipment, the design has been optimized to operate over the supply range of 2.5V to 5.5V and consumes only  $24\mu$ W with a supply of 3V.

The single open-drain output can be switched on with either a north or south pole of sufficient strength. When the magnetic flux density (B) perpendicular to the part marking surface is larger than operate point (Bop), the output is switched on (pulled low). The output is turned off when B becomes lower than the release point (Brp). The output remains off when there is no magnetic field.

## Pin Assignments



#### **Features**

- Omnipolar (North or South Pole) Operation
- 2.5V to 5.5V Operating Range
- High Sensitivity
- Single Open-Drain Output
- Micropower Operation
- Chopper-Stabilized Design Provides
- Superior Temperature Stability
  - Minimal Switch Point Drift
- Enhanced Immunity to Stress
- Good RF Noise Immunity
- -40°C to +85°C Operating Temperature
- ESD > 5kV for U-DFN2020-6, U-DFN2020-3 and X2- DFN2015-3
- ESD > 6kV for SC59
- Low Profile SC59, U-DFN2020-6, U-DFN2020-3 and X2-DFN2015-3 packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

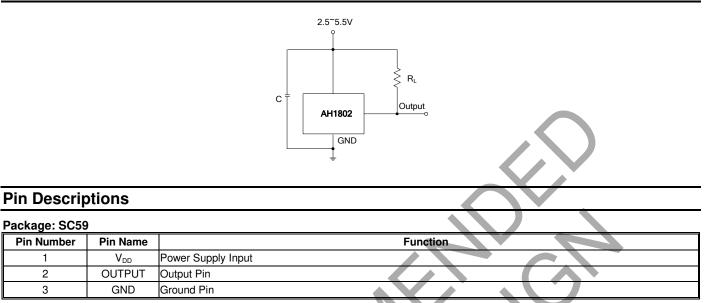
## Applications

- Open and Close Detect for Flip/Slide Cellular Phones
- Smart Cover or Dock Detect for Cellular Phones and Tablets
- Cover or Display Switch in Portable PCs (such as Ultrabook™)
- Display Switch for Portable PCs
- On/Off switch for PDAs and Digital Cameras
- Contactless Switch in Consumer Products

- Notes:
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



## **Typical Applications Circuit**



#### Package: U-DFN2020-3 and X2-DFN2015-3

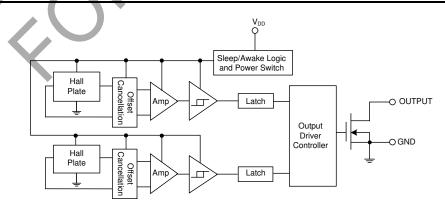
Pin Number	Pin Name		Function
1	V <sub>DD</sub>	Power Supply Input	
2	OUTPUT	Output Pin	
3	GND	Ground Pin	

#### Package: U-DFN2020-6 and X2-DFN2015-3

Pin Number	Pin Name	Function
1	NC	No Connection (Note 4)
2	GND	Ground Pin
3	NC	No Connection (Note 4)
4	V <sub>DD</sub>	Power Supply Input
5	NC	No Connection (Note 4)
6	OUTPUT	Output Pin

Note: 4. NC is *No Connection*—recommendation is to connect the NC pin to ground externally.

#### Functional Block Diagram





#### Absolute Maximum Ratings (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Values	Unit	
V <sub>DD</sub>	Supply Voltage (Note 7)	7	V	
В	Magnetic Flux Density	Unlimited		
Ts	Storage Temperature Range	-65 to +150	°C	
PD	Package Power Dissipation	230	mW	
TJ	Maximum Junction Temperature	150	°C	

6. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
7. The absolute maximum V<sub>DD</sub> of 7V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the sheat the relative maximum rating for extended efficient of the relative maximum rating condition. Notes:

device at the absolute maximum rated conditions for any period of time.

#### Recommended Operating Conditions (@TA = +25°C, unless otherwise specified.)

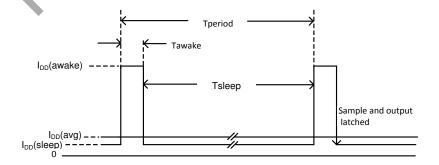
Symbol	Parameter	Conditions	Rating	Unit
V <sub>DD</sub>	Supply Voltage	Operating	2.5 to 5.5	V
T <sub>A</sub>	Operating Temperature Range	Operating	-40 to +85	°C

#### Electrical Characteristics (@ V<sub>DD</sub> = 3V, T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Characteristic	Conditions	Min	Тур	Max	Unit
V <sub>OUT</sub>	Output On Voltage (V <sub>OL</sub> )	I <sub>OUT</sub> = 1mA		0.1	0.3	V
I <sub>OFF</sub>	Output Leakage Current	V <sub>OUT</sub> = 5.5V, B < Brp	-	<0.1	1	μA
		During 'Awake' Period, T <sub>A</sub> = +25°C, V <sub>DD</sub> = 3V		3	6	mA
I <sub>DD</sub> (awake)	C	During 'Awake' Period, T <sub>A</sub> = -40 to +85°C, V <sub>DD</sub> = 2.5 to 5.5V	_	3	10	mA
I <sub>DD</sub> (sleep)	Supply Current	During 'Sleep' Period, T <sub>A</sub> = +25°C, V <sub>DD</sub> = 3V	_	5	10	μΑ
IDD(Sieep)		During 'Sleep' Period, T <sub>A</sub> = -40 to +85°C, Vdd = 2.5~5.5V	_	5	18	μΑ
I <sub>DD</sub> (avg)		Average Supply Current , T <sub>A</sub> = +25°C, V <sub>DD</sub> = 3V	_	8	16	μΑ
IDD(avg)		Average Supply Current , T <sub>A</sub> = -40 to +85°C, Vdd = 2.5 to 5.5V	—	8	23	μΑ
Fc	Chopping Frequency	For Design Information Only	—	300		kHz
Tawake	Awake Time	(Note 8)	—	75	150	μs
Tperiod	Period	(Note 8)	_	75	150	ms
D.C.	Duty Cycle		_	0.1	_	%

Note:

8. When power is initially turned on, V<sub>DD</sub> must be within its correct operating range (2.5V to 5.5V) to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 150ms).



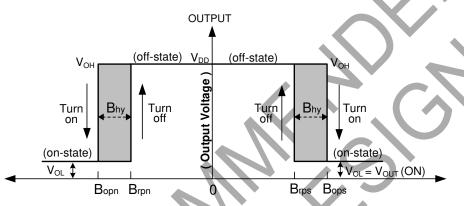


## Magnetic Characteristics (Notes 9 & 10) (@ V<sub>DD</sub> = 3V, T<sub>A</sub> = +25°C, unless otherwise specified.)

				(1mT=10	Gauss)
Symbol	Characteristic	Min	Тур	Max	Unit
Bops(South Pole to Part Marking Side)	Operate Daint	20	28	40	
Bopn(North Pole to Part Marking Side)	Operate Point	-40	-28	-20	
Brps(South Pole to Part Marking Side)	Belease Point	10	20	_	Gauss
Brpn(North Pole to Part Marking Side)	Release Point	—	-20	-10	
Bhy( Bopx-Brpx )	Hysteresis	5	8	_	

Notes:

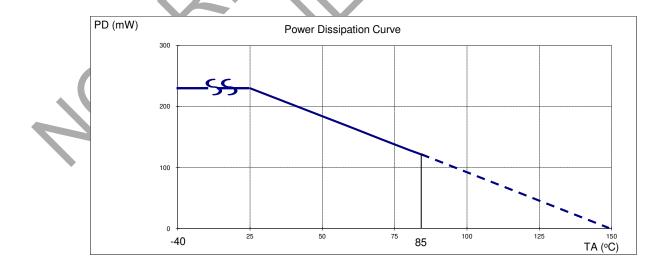
Typical data is at T<sub>A</sub> = +25°C, V<sub>DD</sub> = 3V, and for design information only.
 The magnetic characteristics may vary with supply voltage, operating temperature, and after soldering.



(Magnetic Flux Density B)

## **Performance Characteristics**

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P <sub>D</sub> (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0

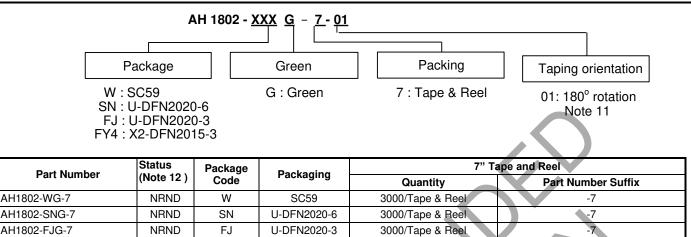




-7

-7

### Ordering Information



3000/Tape & Reel

3000/Tape & Reel

Note: 11. AH1802-FJG-7-01 DFN2020-3 package taping orientation is rotated by 180° compared to standard part AH1802-FJG-7. See package orientation diagrams on pages 9 and 10.

U-DFN2020-3

X2-DFN2015-3

12. NRND = Not Recommended for New Design

NRND

NRND

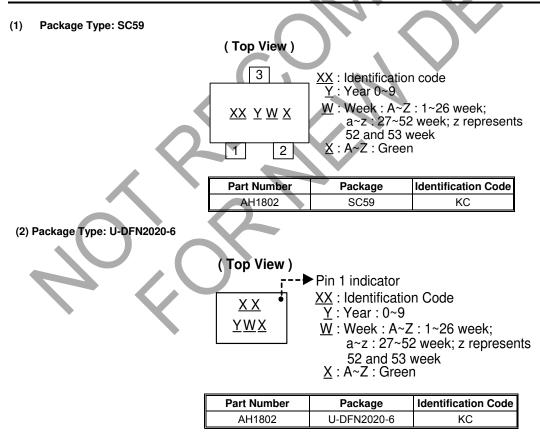
FJ

FY4

#### **Marking Information**

AH1802-FJG-7-01 (Note 8)

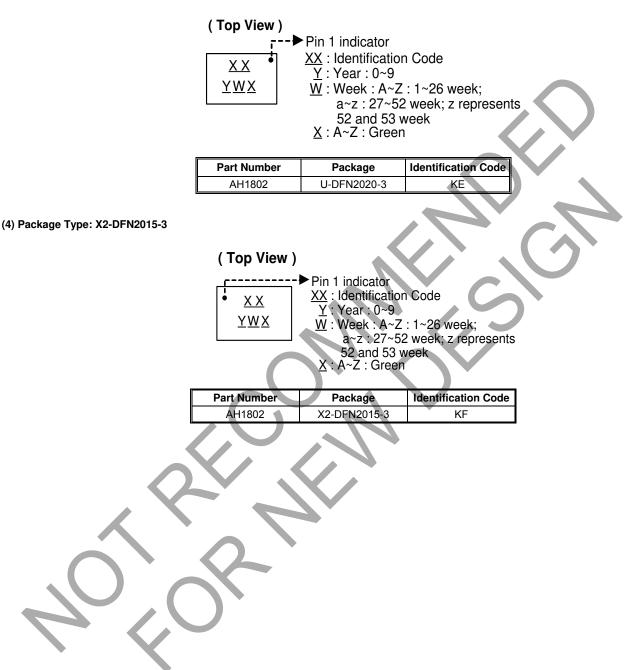
AH1802-FY4G-7





#### Marking Information (continued)

#### (3) Package Type: U-DFN2020-3



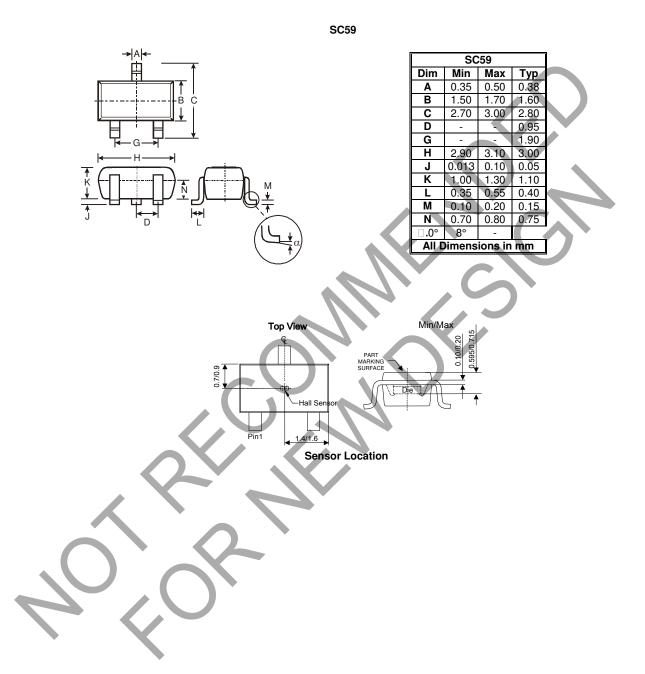
AH1802



### Package Outline Dimensions (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59

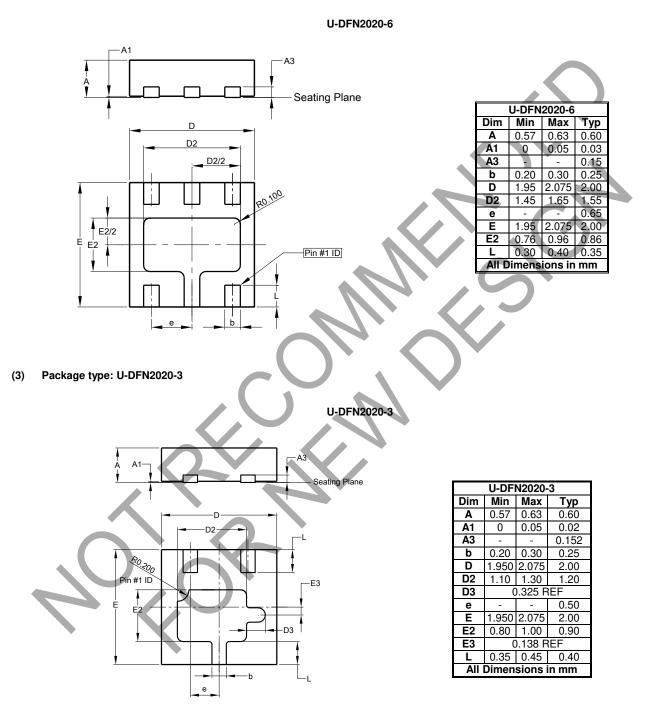




#### Package Outline Dimensions (continued) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (2) Package Type: U-DFN2020-6

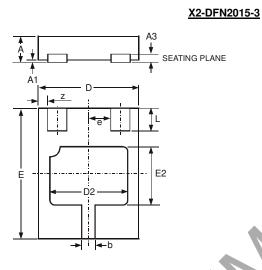




#### Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (4) Package type: X2-DFN2015-3

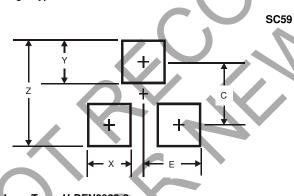


	X2-DF	-3		
Dim	Min	Max	Тур	
Α	-	0.40	-	
A1	0	0.05	0.02	
A3	-	-	0.13	
b	0.20	0.30	0.25	
D	1.45	1.575	1.5	
D2	1.00	1.20	1.10	
е	-	-	0.50	
Е	1.95	2.075	2.00	
E2	0.70	0.90	0.80	
L	0.25	0.35	0.30	
Z	-	-	0.125	
All	Dimen	sions i	in mm	

## **Suggested Pad Layout**

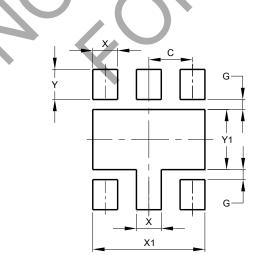
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59



Dimensions	SC59
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35

(2) Package Type: U-DFN2020-6



Dimensions	Value (in mm)
С	0.65
G	0.15
Х	0.37
X1	1.67
Y	0.45
Y1	0.90

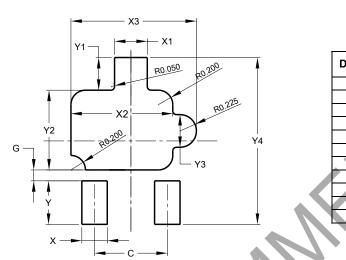
U-DFN2020-6



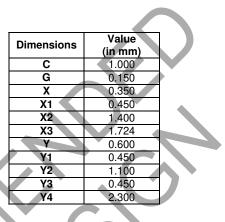
## Suggested Pad Layout (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (3) Package Type: U-DFN2020-3



U-DFN2020-3



Value

(in mm) 1.000

0.150

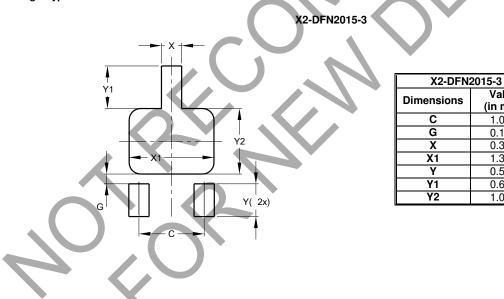
0.310

1.300 0.500

0.650

1.000

#### (4) Package Type: X2-DFN2015-3





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